IRFR120, IRFU120, SiHFR120, SiHFU120

Vishay Siliconix

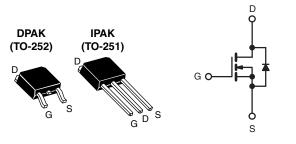
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	100				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.27				
Q _g (Max.) (nC)	16				
Q _{gs} (nC)	4.4				
Q _{gd} (nC)	7.7				
Configuration	Single				



N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR120, SiHFR120)
- Straight Lead (IRFU120, SiHFU120)
- Available in Tape and Reel
- · Fast Switching
- · Ease of Paralleling
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION							
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lead (Pb)-free and Halogen-free	SiHFR120-GE3	SiHFR120TR-GE3a	SiHFR120TRR-GE3a	SiHFR120TRL-GE3a	SiHFU120-GE3		
Lead (Pb)-free	IRFR120PbF	IRFR120TRPbFa	IRFR120TRRPbFa	IRFR120TRLPbFa	IRFU120PbF		
Lead (Fb)-liee	SiHFR120-E3	SiHFR120T-E3a	SiHFR120TR-E3a	SiHFR120TL-E3a	SiHFU120-E3		

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	100	V	
Gate-Source Voltage			V_{GS}	± 20	7 v	
Continuous Drain Current	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	1	7.7		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	4.9	Α	
Pulsed Drain Current ^a			I _{DM}	31		
Linear Derating Factor				0.33	W/°C	
Linear Derating Factor (PCB Mount)e				0.020	VV/ C	
Single Pulse Avalanche Energy ^b			E _{AS}	210	mJ	
Repetitive Avalanche Currenta			I _{AR}	7.7	Α	
Repetitive Avalanche Energy ^a			E _{AR}	4.2	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$				42	W	
Maximum Power Dissipation (PCB Mount)e	T _A =	25 °C	P_D	2.5	7 vv	
Peak Diode Recovery dV/dtc			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	%0	
Soldering Recommendations (Peak Temperature) ^d	for	10 s		260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 5.3 mH, R_g = 25 Ω , I_{AS} = 7.7 A (see fig. 12).
- c. $I_{SD} \le 9.2$ A, $dI/dt \le 110$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

IRFR120, IRFU120, SiHFR120, SiHFU120

Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	-	110		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zova Cata Valtaga Dvain Cuwant		V _{DS} =	= 100 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C		-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 4.6 A ^b	-	-	0.27	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 4.6 A	1.6	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	360	-	pF
Output Capacitance	C _{oss}]	$V_{DS} = 25 \text{ V},$	-	150	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	34	-	
Total Gate Charge	Qg				-	16	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b		-	-	4.4	
Gate-Drain Charge	Q _{gd}	1	goo ng. o ana ro	-	-	7.7	
Turn-On Delay Time	t _{d(on)}			-	6.8	-	
Rise Time	t _r	V _{DD} = 50 V, I _D = 9.2 A,		-	27	-	ns
Turn-Off Delay Time	t _{d(off)}	R_g = 18 Ω , R_D = 5.2 Ω , see fig. 10 ^b		-	18	-	
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	nЦ
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	7.7	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	31	
Body Diode Voltage	V_{SD}	T _J = 25 °C	$I_{S} = 7.7 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 05 °O I	_ 0.0 A dl/dt 100 A/h	-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 9.2 \text{A}, dI/dt = 100 \text{A}/\mu \text{s}^{\text{b}}$		-	0.65	1.3	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

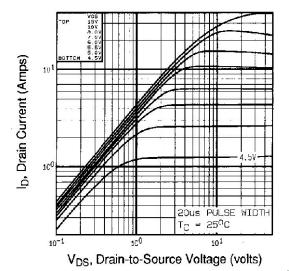


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

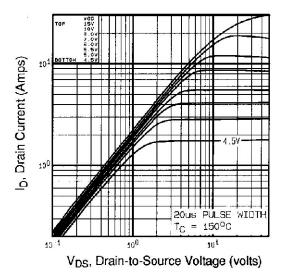
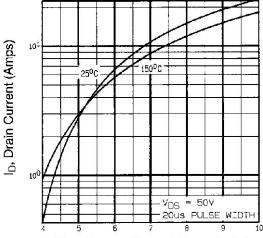


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



V_{GS}, Gate-to-Source Voltage (volts)

Fig. 3 - Typical Transfer Characteristics

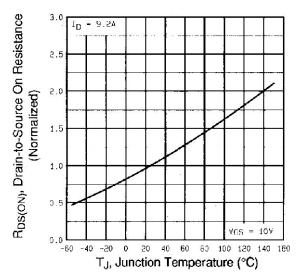


Fig. 4 - Normalized On-Resistance vs. Temperature

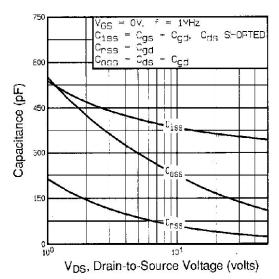


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

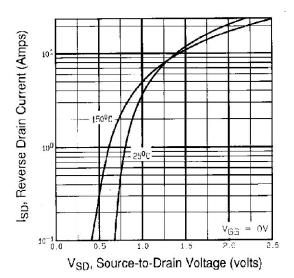


Fig. 7 - Typical Source-Drain Diode Forward Voltage

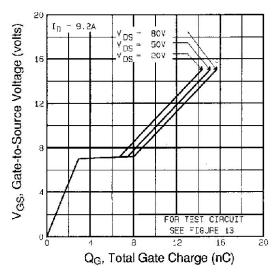


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

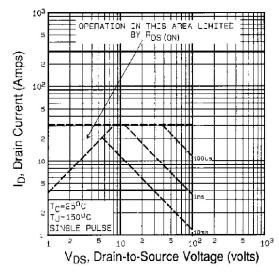


Fig. 8 - Maximum Safe Operating Area

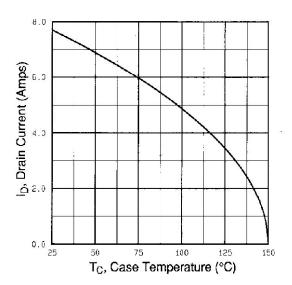


Fig. 9 - Maximum Drain Current vs. Case Temperature

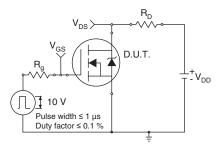


Fig. 10a - Switching Time Test Circuit

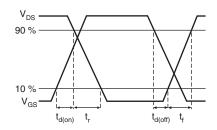


Fig. 10b - Switching Time Waveforms

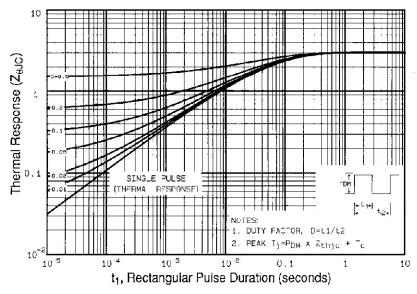


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

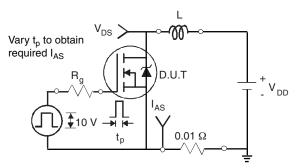


Fig. 12a - Unclamped Inductive Test Circuit

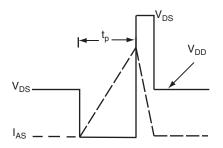


Fig. 12b - Unclamped Inductive Waveforms

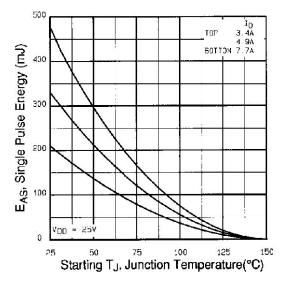


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

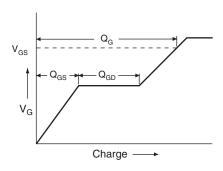


Fig. 13a - Basic Gate Charge Waveform

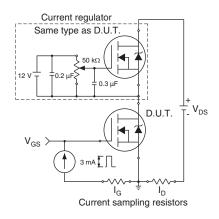
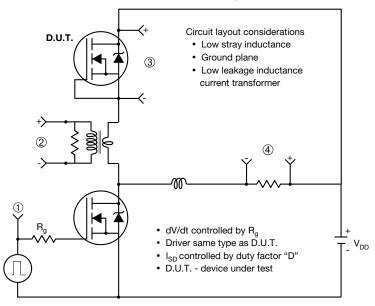


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



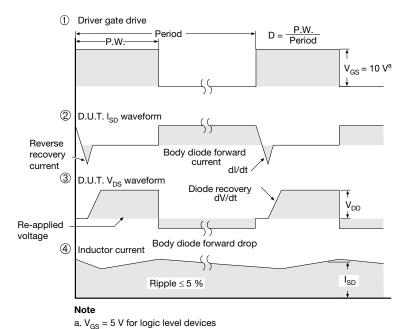
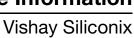


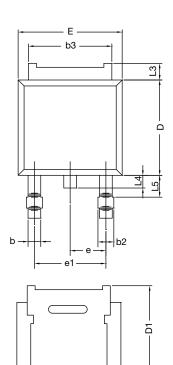
Fig. 14 - For N-Channel

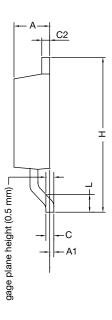
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TO-252AA Case Outline





	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
e	2.28 BSC		0.090	BSC
e1	4.56	BSC	0.180	BSC
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060
ECN: T16-0236-Rev. P, 16-May-16				

DWG: 5347 Notes

• Dimension L3 is for reference only.



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29	BSC	2.29	BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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